



Docket No.: 3749-0106PUS1
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Hiroyuki OSADA et al.

Application No.: 10/551,809

Art Unit: 1744

Filed: September 30, 2005

Examiner: Not Yet Assigned

For: METHOD OF FIXING LOW-MOLECULAR
COMPOUND TO SOLID-PHASE SUPPORT

SECOND PRELIMINARY AMENDMENT

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

The following preliminary amendments and remarks are respectfully submitted in connection with the above-identified application.

This amendment includes:

Amendments to the Specification begin on page 2 of this paper.

Remarks/Arguments begin on page 3 of this paper.